

PRIMERGY TX300 S6

System configurator and order-information guide

June 2012

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PRIMERGY Server

Instructions

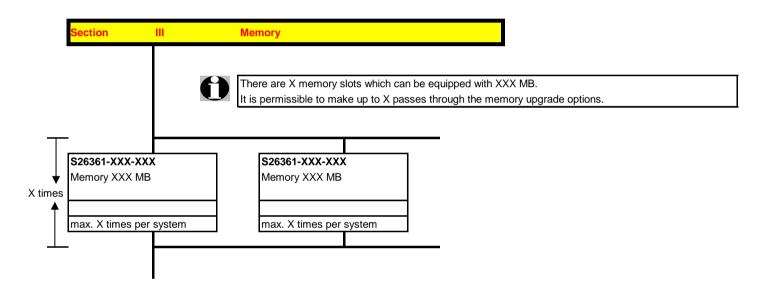
This document contains basic product and configuration information that will enable you to configure your system via PC-/SystemArchitect.

Only these tools will ensure a fast and proper configuration of your PRIMERGY server or your complete PRIMERGY Rack system.

You can configure your individual PRIMERGY server in order to adjust your specific requirements.

The System configurator is divided into several chapters that are identical to the current price list and PC-/SystemArchitect.

Please follow the lines. If there is a junction, you can choose which way or component you would like to take. Go through the configurator by following the lines from the top to the bottom.



In one chapter you can only select as many components (here 4x) as the arrow indicates.



Please note that there are information symbols which indicate necessary information.



For further information see:

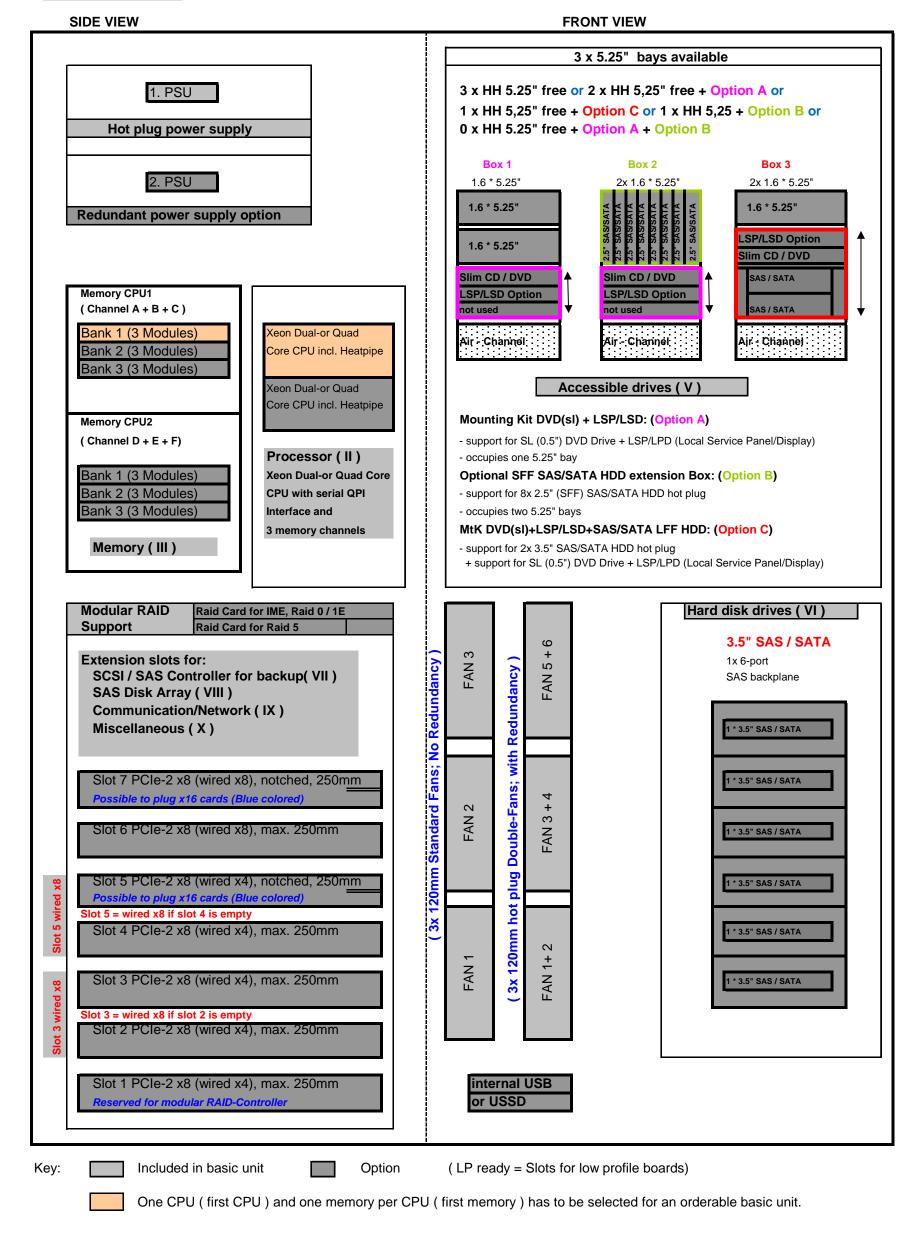
http://ts.fujitsu.com/products/standard_servers/index.html (internet)

https://partners.ts.fujitsu.com/com/order-supply/configurators/primergy_config/current/Pages/default.aspx (extranet)

Prices and availability see price list and PC-/SystemArchitect. Subject to change and errors excepted.

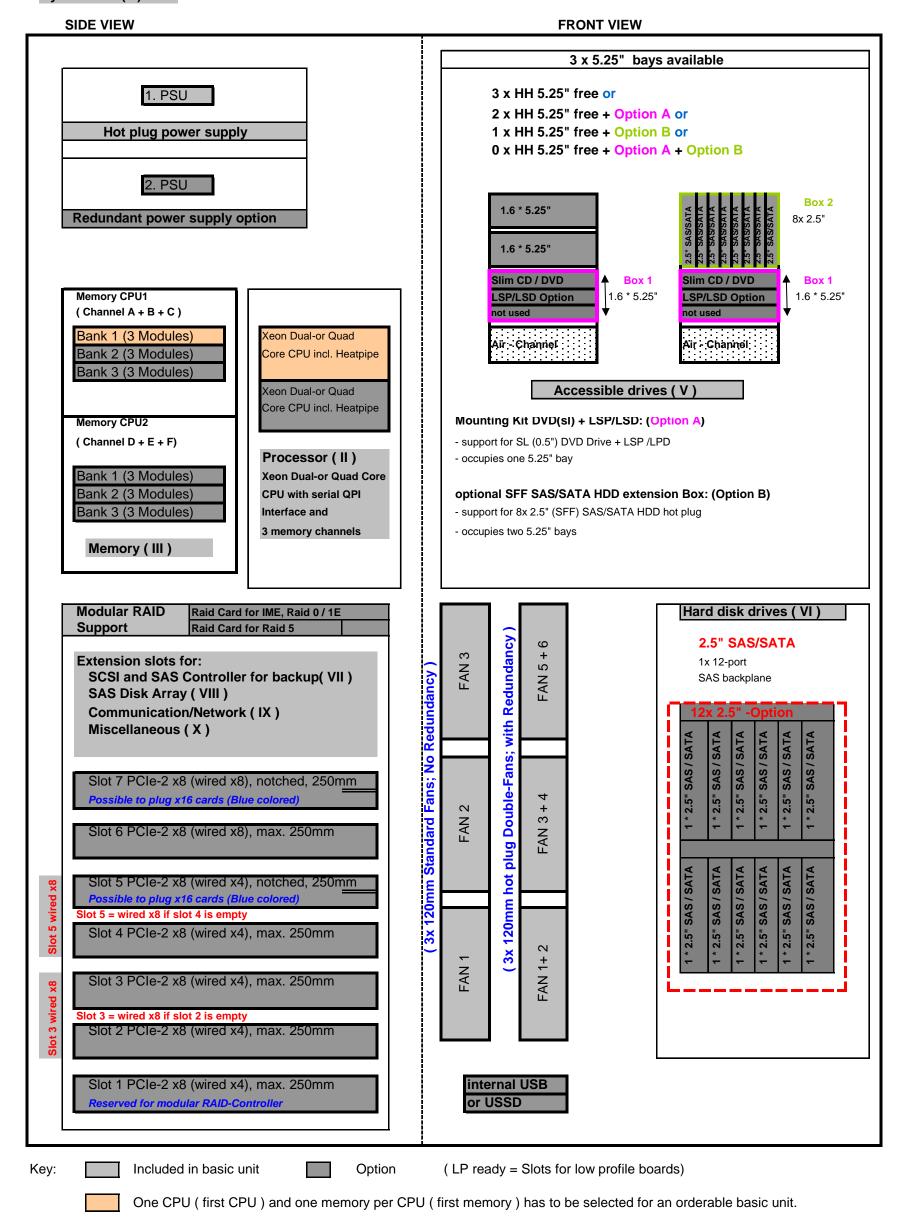
Configuration diagram PRIMERGY TX300 S6

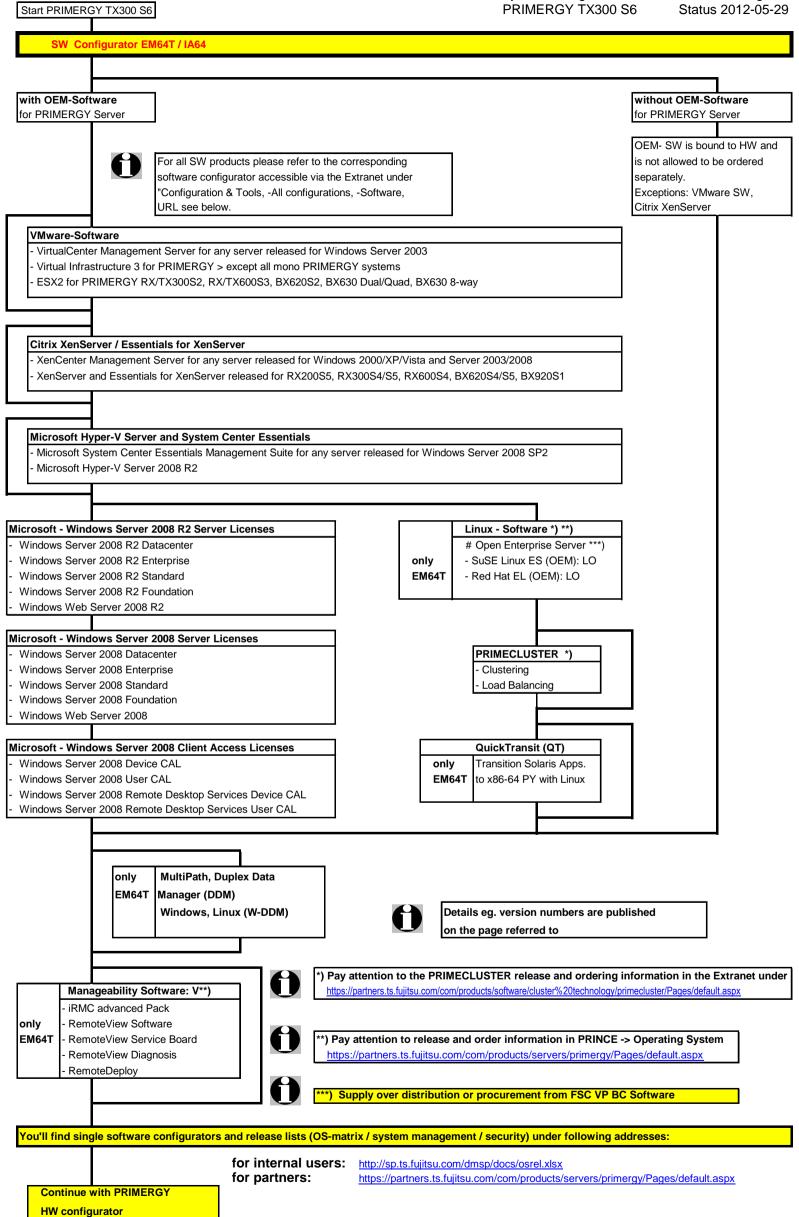
System unit (I)



Configuration diagram PRIMERGY TX300 S6

System unit (I)





Section

SAS - Basic units



SAS - System unit, Rack and Floorstand including:

- By a key lockable front bezel in floorstand version
- Basic units with:
- A.) 1x 800W Hot-Plug Power Supply (no redundancy) + 3x 120mm Standard Fans (no redundancy)
- B.) 2x 800W Hot-plug and redundant Power Supplies + 3x hot-plug and redundant Double Fans
- 9 memory DIMMs per CPU (max 96GB) => Total 18 DIMMs (max 192GB) for two CPU's
- SAS backplane with 6 x 1" bays for 3.5" hot plug SAS or SATA HD`s
- * 3 drive bays 5,25" for accessible drives free available.
- * Integrated ServerView Diagnostics Technology (Diagnosis LED`s) for indication of internal failed components

Options

- * 2nd hot plug power supply module 800W (PSU) for redundancy in Basic Unit A.)
- * 12x 2.5" HD backplane conversion kit
- * Optional modular RAID 0/1 controllers with IME (Integrated Mirroring Enhanced) support based on LSI 1064 or LSI SAS2008 chipset or as alternative
- optional modular RAID 5 controller based on LSI SAS2108 chipset
- * One 0,5" bay can be configured with an optional LC- display for LocalView in a drawer or with an optional CSS (Customer Self Service) modul for indication of a failed component via LED's Simultaneously components are marked which can be replaced by the customer.

 This LEDs can be dispalyed during service even without mains connection.

Systemboard D2619 with:

- * Up to two Xeon Dual Core, Quad-Core, Turbo Quad Core or Turbo Six Core CPU's (LGA 1366 socket) with serial QPI links (Quick Path Interconnect) and three memory channels per CPU First CPU has to be selected for an orderable basic unit,
- * Chipset Intel® 5520P (codenamed Tylersburg-EP or 36D)
- * 7 PCI slots: 2x PCIe-2 x8 (wired x8, notched, possible to plug x16 card)
 - 5x PCle-2 x8 (wired x4)

From 4 PCle-slots each two wired x4 slots can be combined to one wired x8 slot One PCle-2-slot is populated with one of two possible modular Raid-controllers.

- * 18 memory slots for max. 384 GB (12x 32GB) RAM DDR3 available
- Memory is divided into 9 DIMMs per CPU (3 channels with 3 slots per channel)
- Max. three 8GB modules or two 16/32GB quad rank modules are possible per channel
- First Memory (one module) has to be selected for an orderable basic unit per CPU
- Memory upgrade is possible module wise
- Memory mirrroring is supported with 2 identical modules in channel A+B CPU 1 or D+E CPU 2
- Hot Spare Memory is supported with 3 identical modules in channel A+B+C CPU 1 or D+E+F CPU 2
- SDDC (Chipkill) is supported for memory modules,
- * Dual Port 10/100/1000 x4 PCI Express* Gigabit Ethernet Intel LAN controller Zoar on-board
- * iRMC S2 (integrated Remote Management Controller) on-board server management controller with dedicated 10/100 Service LAN-port and integrated graphics controller.

The Service LAN-port can be switched alternatively on standard Gbit LAN port 1

- * Graphics Controller integrated in iRMC S2 (integrated Remote Management Controller): 1600x1200x16bpp 60Hz, 1280x1024x16bpp 60Hz, 1024x768x32bpp 75Hz, 800x600x32bpp 85Hz, 640x480x32bpp 85Hz
- (1280x1024x24bpp 60Hz only possible if local monitor or remote video redirection is off)

Α

Interfaces at the rear:

- * 1x RS-232-C (serial, 9 pins) (usable for BMC or OS or shared)
- * 1x RS-232-C (serial, 9 pins)
- * 1x VGA (15 pins)
- * 4x USB 2.0 (UHCI) with 480MBit/s, no USB wakeup
- 2x LAN RJ45, 1x Service-LAN RJ45

Interfaces on the front:

- * 3x USB 2.0 (UHCI) with 480MBit/s, no USB wakeup
- * 1x VGA (15 pins) as an option

Interfaces internal:

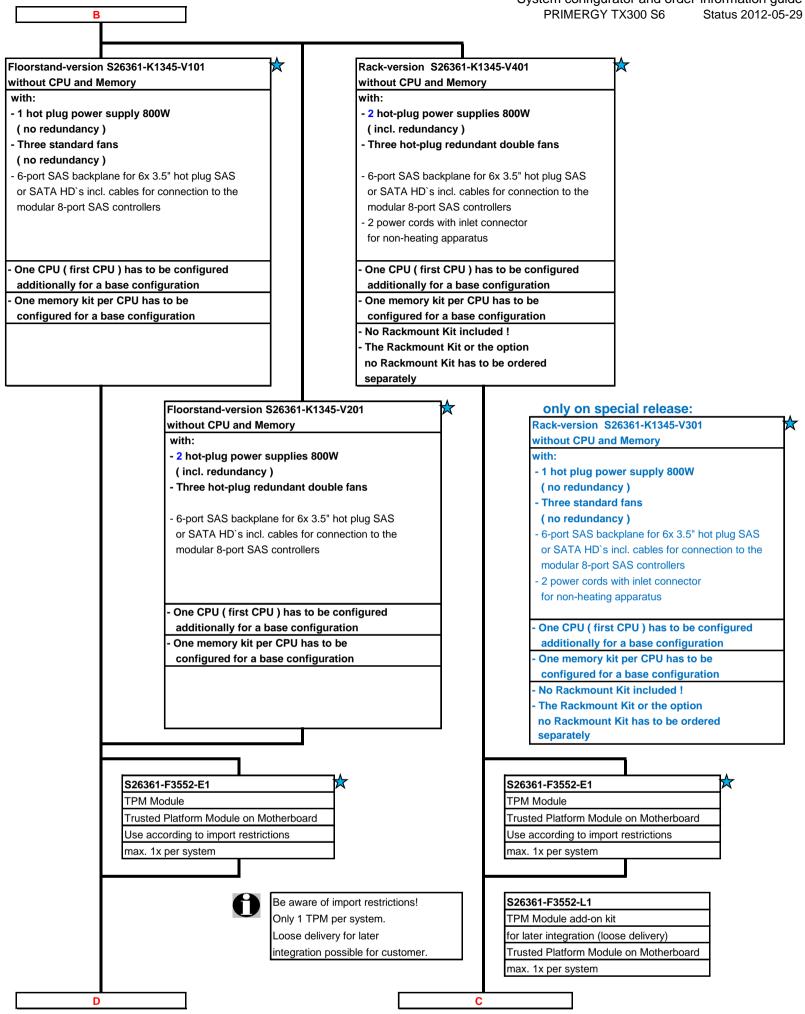
- 2x released internal USB Interfaces for backup devices,
- * 1x USB **2.0** (UHCI) with **480MBit/s** for dongle funcionality, no USB wakeup

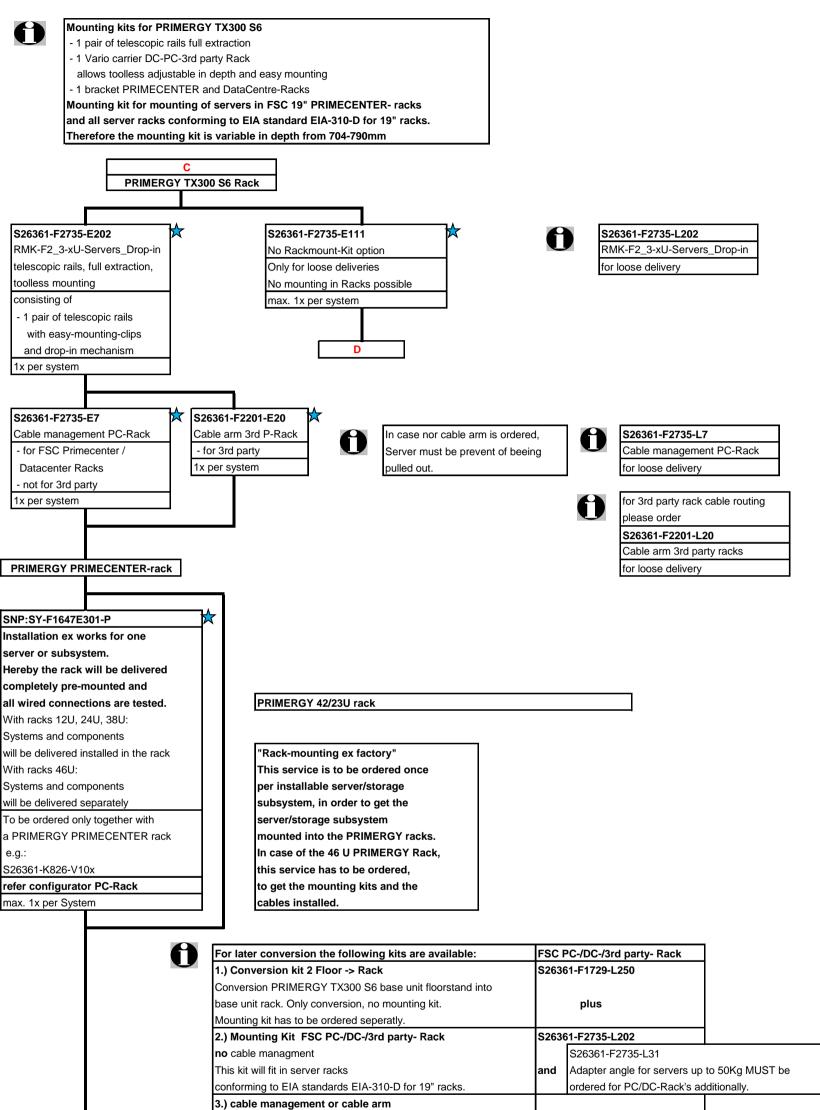
Cables:

- * SATA cable for DVD.
- * 2x SAS cables for connection of 4 SAS-ports each incl. signaling

* ServerView Suite Software package incl. ServerStart, ServerBooks, Management Software and Updates

* Documentation engl. (multilingual on CD)





or

either one to be ordered **S26361-F2735-L7**

S26361-F2201-L20

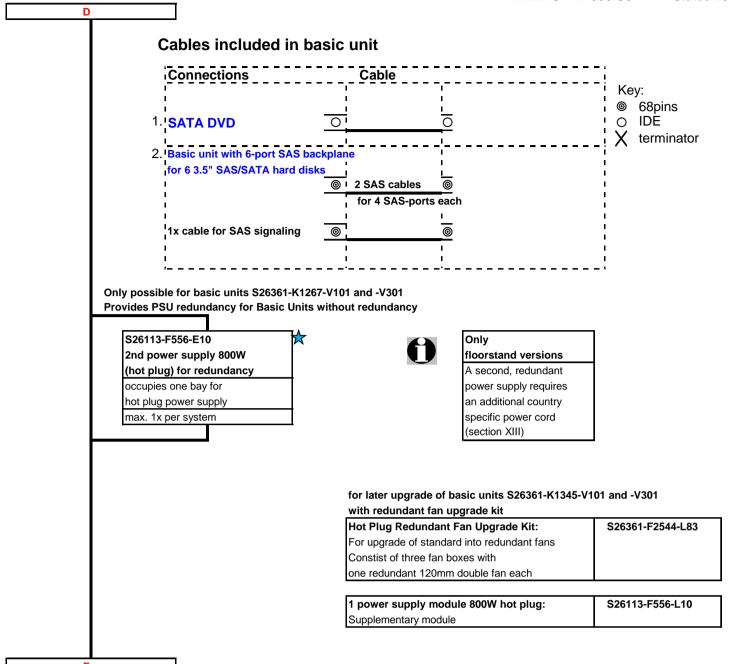
to be ordered additionally

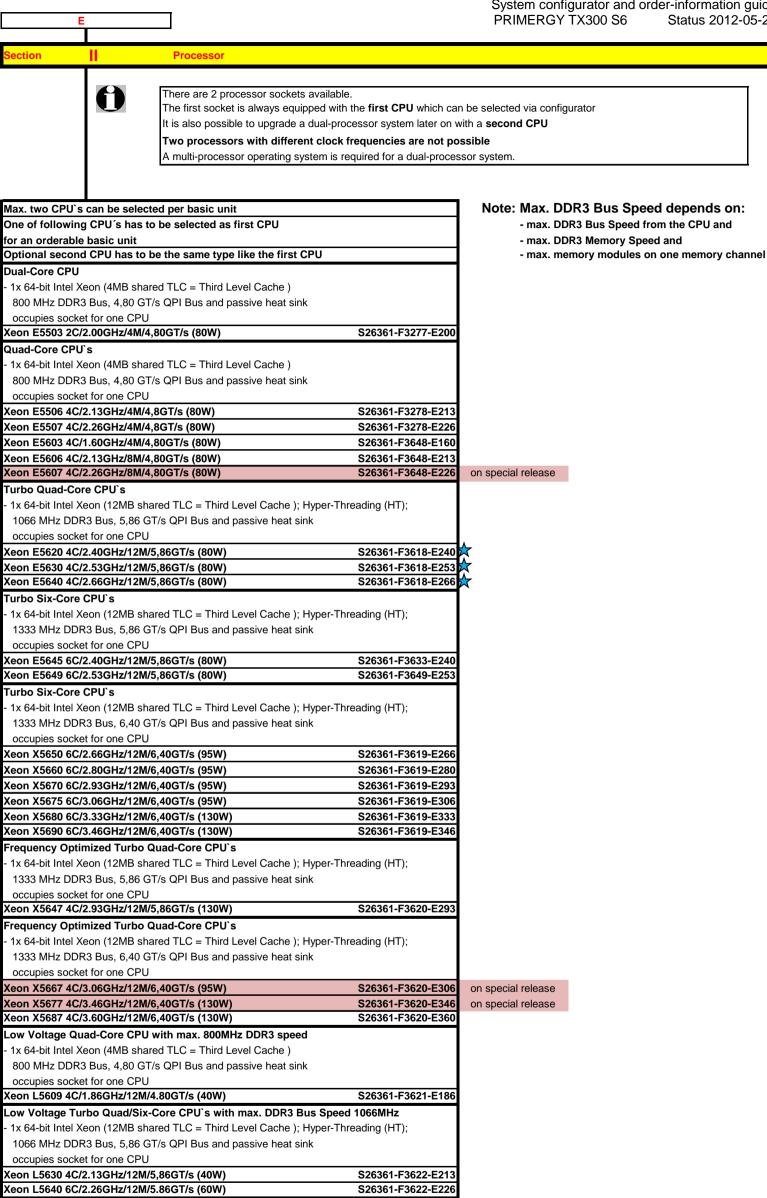
FSC PC-/DC- Rack cable management

for mounting in DC-, PC-racks

3rd party- Rack cable arm

D





F

Section III Memory



- There are 9 memory slots for max.

72GB (9x 8GB single / dual rank 1.5V RDIMM's)

96GB (6x 16GB quad rank 1.5V RDIMMs)

12GB (6x 2GB UDIMMs)

=> max. 192GB for two CPU's (96GB per CPU)

(For explanation of following terms refer to section "Memory Configurations"

- The memory area is divided into 3 channels per CPU with 3 slots per channel

- Slot 1 of each channel belongs to memory bank 1, the slot 2 belongs to memory bank 2 and slot 3 belongs to memory bank 3

Systems with 3DPC (9 DIMMs / CPU) do not support mix of dual rank and quad rank modules

Registered and unbuffered memory modules can be selected

No mix of registered and unbuffered modules allowed.

DDR3 1066 and 1333MHz modules can be mixed, but run always with the slower speed.

With two DIMMs per channel, 1.5V DIMMs operate with 1333Mhz, 1.35V with 1066MHz as max., dep. on CPU

If 1.5V DIMMs and 1.35V (Low Voltage) DIMMs are mixed, DIMMs will run at 1.5V

SDDC (Chipkill) is supported only for registered memory modules.

1.) In the "Independent Channel Mode" is following configuration possible

- Each slot can optionally be equipped either with registered x4 organized DDR3 modules:

2GB single rank, 4GB and 8GB dual rank, 16GB quad rank

or with unbuffered x8 organized DDR3 modules: 2GB dual rank

2.) In the "Spare Channel Mode" is following configuration possible

- Each memory bank can optionally be equipped with 3x2GB single rank,

3x4GB and 3x8GB dual rank or 3x 16GB quad rank DDR3 modules.

Each slot of one bank has to be equipped with identical modules for spare channel mode

In channel A and B of CPU 1 or channel D and E of CPU 2 $\,$ are always the active memory modules,

in channel C of CPU 1 and channel F of CPU 2 is always the spare module

No special order codes with UDIMMs are offered for this mode

3.) In the "Mirrored Channel Mode" is following configuration possible

- Each memory bank can optionally be equipped with 2x2GB single rank,

2x4GB and 2x8GB **dual rank** or 2x16GB quad rank DDR3 modules.

In each memory bank channel A and B of CPU 1 or channel D and E of CPU 2 have to be equipped with identical modules for mirrored channel mode. Channel C of CPU 1 and channel F of CPU 2 is not equipped

In channel B is always the mirrored memory of channel A of CPU 1

In channel E is always the mirrored memory of channel D of CPU $\mathbf 2$

No special order codes with UDIMMs are offered for this mode

- For each CPU minimum 1 memory module has to be configured in Independent Channel Mode

(=> Additional memory extensions can still be configured up to eight times per CPU) or

one bank has to be equipped with two modules (channel A+B for CPU 1 or D+E for CPU 2) in Mirrored Channel Mode

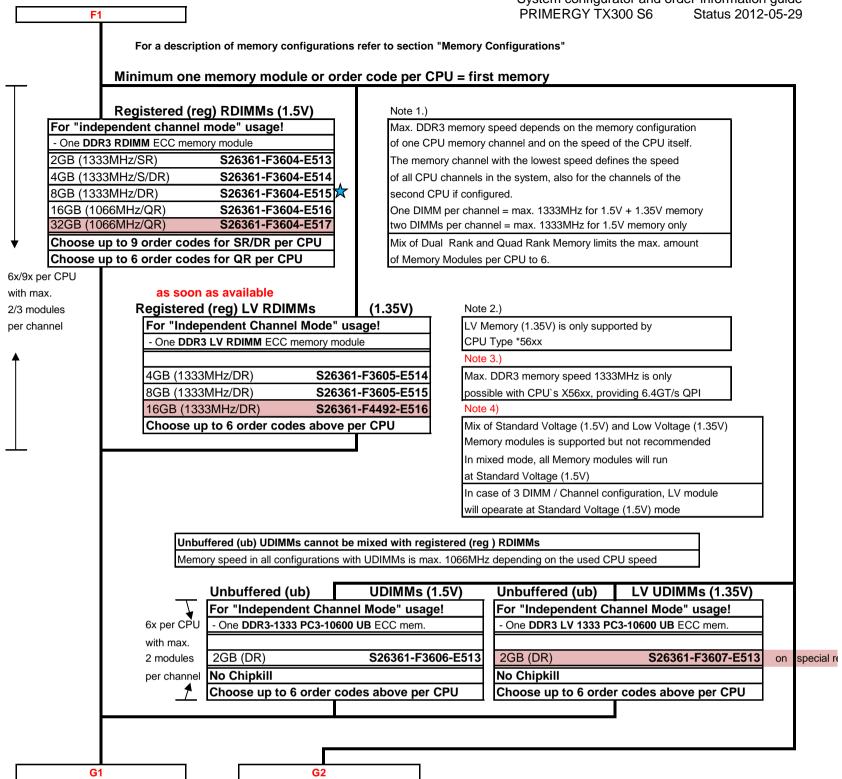
(=> Additional memory extensions can still be configured up to two times per CPU) $\ensuremath{\text{or}}$

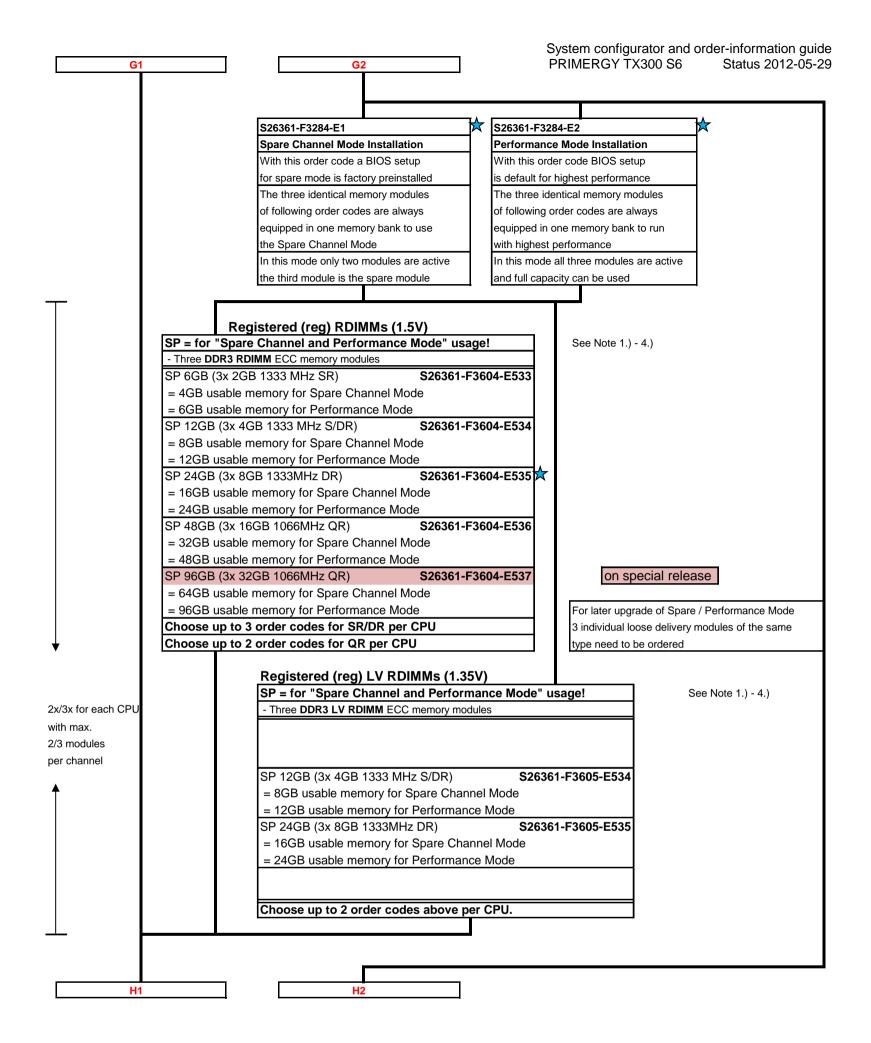
one bank has to be equipped with three modules (channel A+B+C for CPU 1 or D+E+F for CPU 2)

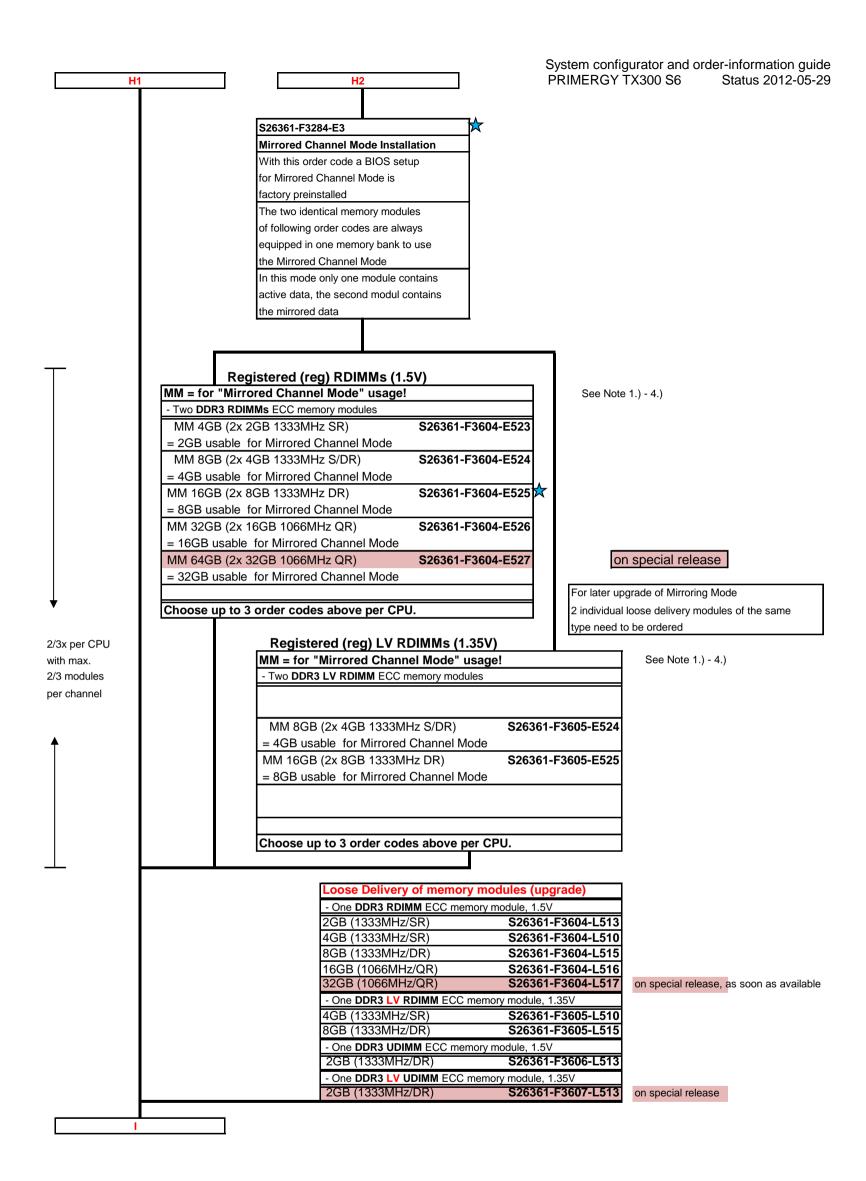
in Spare Channel Mode or Performance Mode

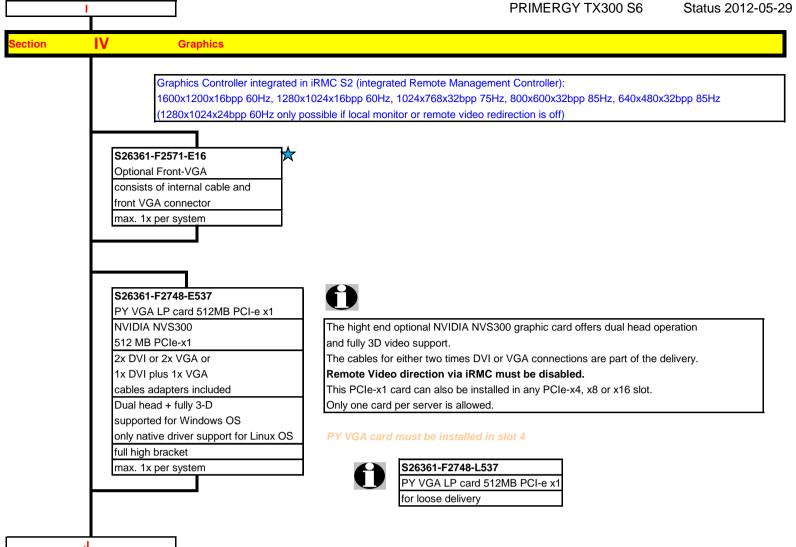
(=> Additional memory extensions can still be configured up to two times per CPU)

F1









Memory Configuration PRIMERGY TX300 S6

Each CPU offers 9 Slots for DDR3 Memory Modules organised in 3 Banks and 3 Channels.

If you need more than 9 Slots you have to configure the 2nd CPU.

Depending on the amount of memory configured you can decide between 4 basic modes of operation (see explanation below).

There are 4 different kinds of DDR3 Memory Modules available: UDIMM / UDIMM LV and RDIMM / RDIMM LV UDIMM and RDIMM offer different functionality. Mix of UDIMM + RDIMM is not alloved.

Mixing of Standard + Low Voltage DIMM's of the same type is allowed, but not recommendet (therefore not configurable ex works) If 1.5V and LV/LV / 1.35V DIMMs are mixed, the DIMMs will run at 1.5V

Mixing of SR / DR and QR Memory Modules will limit the max. amount of modules per CPU to 6.

Mode	Configuration	UDIMM	RDIMM	Application
chip kill support	any	n.a.	yes	detect multi-bit errors
Independant Channel Mode	1, 2 or 3 Modules per Bank	Х	Х	offers max. flexibility, upgradeability, capacity use UDIMM modules for lowest cost
Mirrored Channel Mode	2 identical Modules / Bank	**)	Х	offers maximum security
Performance Mode *)	3 identical Modules / Bank	**)	Х	offers maximum performance and capacity
Spare Channel Mode *)	3 identical Modules / Bank	**)	Х	balances security and capacity

^{*) =} Performance Mode and Spare mode use different BIOS settings.

x = order codes available

Capacity	Configuration	UDIMM	RDIMM	RDIMM LV	Notes
Min. Memory per CPU	1 Module / CPU	1x2GB	1x2GB	1x 4GB	with one CPU
Max. Memory per CPU	6/9 Modules / CPU	6x2GB	6x16GB	6x 8GB	with one CPU
Max. Memory per System	12 Modules / System	24GB	192GB	96GB	if second CPU is configured

Memory-Speed:

Max. DDR3 memory speed depends on the memory configuration on one memory channel and the speed of the CPU

One DIMM per channel = max. 1333MHz, two DIMMs per channel = max. 1333MHz, three DIMMs per channel = max. 800MHz, The memory channel with the lowest speed defines the speed of all CPU channels in the system,

DIMM Type	DIMM Slots per Channel	DIMMs populated per Channel	Memory Speed max (CPU dependent)	Ranks per DIMM
RDIMM 1.5V 1333Mhz	2/3 2/3 2/3 2/3 2/3 3	1 1 2 2 2 3	800, 1066, 1333 800, 1066 800, 1066, 1333 800 800	SR / DR QR Mix of SR + DR Mix of QR + SR / DR Mix of SR + DR
RDIMM LV / 1.35V 1333Mhz	2/3 2/3 2/3 2/3 3	1 1 2 2 3	800, 1066, 1333 800, 1066 800, 1066 800 800	SR / DR QR* Mix of SR + DR Mix of QR* + SR / DR Mix of SR + DR **
UDIMM 1.5V 1333Mhz	2/3	1 2	800, 1066, 1333 800, 1066, 1333	SR / DR Mix of SR + DR
UDIMM LV / 1.35V 1333Mhz	2/3	1 2	800, 1066, 1333 800, 1066	SR / DR Mix of SR + DR

^{*} no memory modules released for this configuration

^{**) =} technically possible but no Order Numbers available, use at your own risk

^{**} lost LV-mode, memory will switch to 1,5V Vcc automatically

Used CPU	Max. Memory-Bus speed depending on DIMMs / channel if following memory speed is used for specific CPU's														
	UDIMM 1333 MHz 1.5V		UDIMM 1333 MHz LV / 1.35V		RDIMM 1333 MHz 1.5V		RDIMM 1333 MHz LV / 1.35V			RDIMM 1066 MHz (QR) 1.5V					
Populated Dimms / Channel	1	2	3	1	2	3	1	2	3	1	2	3	1	2	3
Dual-Core CPU															
with max. 800MHz DDR3 speed (4.8GT/s)															
Xeon E5503 2C/2.00GHz/2M/4,80GT/s (80W)	800	800	-	800	800	-	800	800	800	800	800	-	800	800	-
Quad-Core CPU`s															
with max. 800MHz DDR3 speed (4.8GT/s)															
Xeon E5506 4C/2.13GHz/4M/4,8GT/s (80W)	800	800	-	800	800	-	800	800	800	800	800	-	800	800	-
Xeon E5507 4C/2.26GHz/4M/4,8GT/s (80W)	800	800	-	800	800	-	800	800	800	800	800	-	800	800	•
Turbo Quad-Core CPU`s															
with max. 1066MHz DDR3 speed (5.86GT/s)															
Xeon E5620 4C/2.40GHz/12M/5,86GT/s (80W)	1066	1066	-	1066	1066	-	1066	1066	800	1066	1066	-	1066	800	-
Xeon E5630 4C/2.53GHz/12M/5,86GT/s (80W)	1066	1066	-	1066	1066	-	1066	1066	800	1066	1066	-	1066	800	-
Xeon E5640 4C/2.66GHz/12M/5,86GT/s (80W)	1066	1066	-	1066	1066	-	1066	1066	800	1066	1066	-	1066	800	-
Turbo Six-Core CPU's															
with max. 1333MHz DDR3 speed (6.4GT/s)															
Xeon X5650 6C/2.66GHz/12M/6,40GT/s (95W)	1333	1333	-	1333	1066	-	1333	1333	800	1333	1066	-	1066	800	-
Xeon X5660 6C/2.80GHz/12M/6,40GT/s (95W)	1333	1333	-	1333	1066	-	1333	1333	800	1333	1066	-	1066	800	-
Xeon X5670 6C/2.93GHz/12M/6,40GT/s (95W)	1333	1333	-	1333	1066	-	1333	1333	800	1333	1066	-	1066	800	-
Xeon X5680 6C/3.33GHz/12M/6,40GT/s (130W)	1333	1333	-	1333	1066	-	1333	1333	800	1333	1066	-	1066	800	-
Frequency Optimized Turbo Quad-Core CPU's															
with max. 1333MHz DDR3 speed (6.4GT/s)															
Xeon X5667 4C/3.06GHz/12M/6,40GT/s (95W)	1333	1333	-	1333	1066		1333	1333	800	1333	1066	-	1066	800	١
Xeon X5677 4C/3.46GHz/12M/6,40GT/s (130W)	1333	1333	-	1333	1066	-	1333	1333	800	1333	1066	-	1066	800	-
Low Voltage Quad-Core CPU															
with max. 1066MHz DDR3 speed (4.8GT/s)															
Xeon L5609 4C/1.86GHz/12M/4.80GT/s (40W)	1066	1066	-	1066	1066	-	1066	1066	800	1066	1066	-	1066	1066	-
Low Voltage Turbo Quad-Core CPU															
with max. 1066MHz DDR3 speed (5.86GT/s)															
Xeon L5630 4C/2.13GHz/12M/5,86GT/s (40W)	1066	1066	-	1066	1066	-	1066	1066	800	1066	1066	-	1066	800	-
Xeon L5640 6C/2.40GHz/12M/5.86GT/s (60W)	1333	1333	-	1333	1066	-	1333	1333	800	1333	1066	-	1066	800	-

SR - Single Rank - 1Rx4 DR - Dual Rank - 2Rx4 QR - Quad Rank - 4Rx4

1DPC = 1 DIMM per Channel 2DPC = 2 DIMM per Channel 3DPC = 3 DIMM per Channel



Configuration hints:

- The memory sockets on the systemboard offer a color coding:

Bank II black sockets
Bank III blue sockets
Bank III green sockets

- A so called Bank consits of 1 memory module on every Channel available on one CPU (examples see below)

Bank I on CPU 1

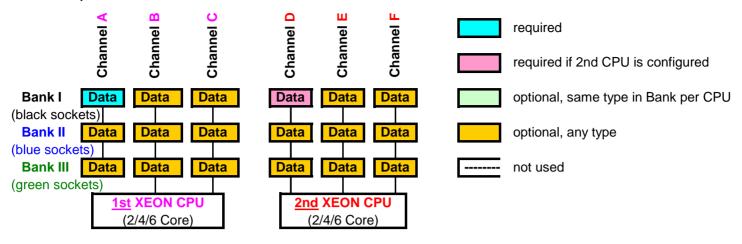
Bank II on CPU 1

Bank III on CPU 1

Bank III on CPU 2

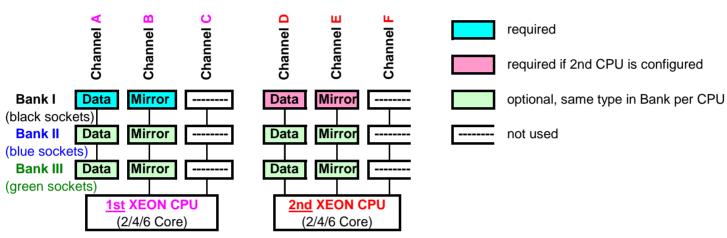
- See below and next page for a detailed descriptions of the memory configuration supported.

1. Independent Channel Mode



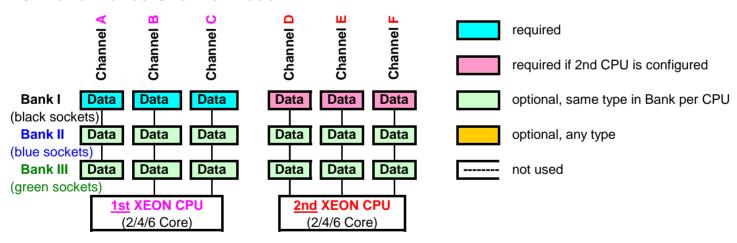
Independent Channel Mode allows all channels to be populated in any order Can run with differently rated DIMMs and use the settings of the slowest DIMM installed in the system

2. Mirrored Channel Mode



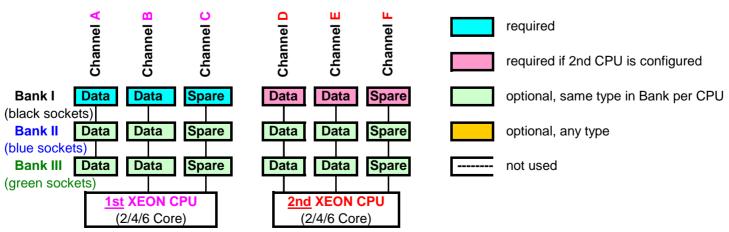
Mirrored Channel Mode requires identical modules on channel A and B (1st CPU) or channel D and E (2nd CPU) 50% of the capacity is used for the mirror => the available memory for applications is only half of the installed memory Channel C (1st CPU) or channel F (2nd CPU) are not usable in Mirrored Channel Mode

3. Performance Channel Mode

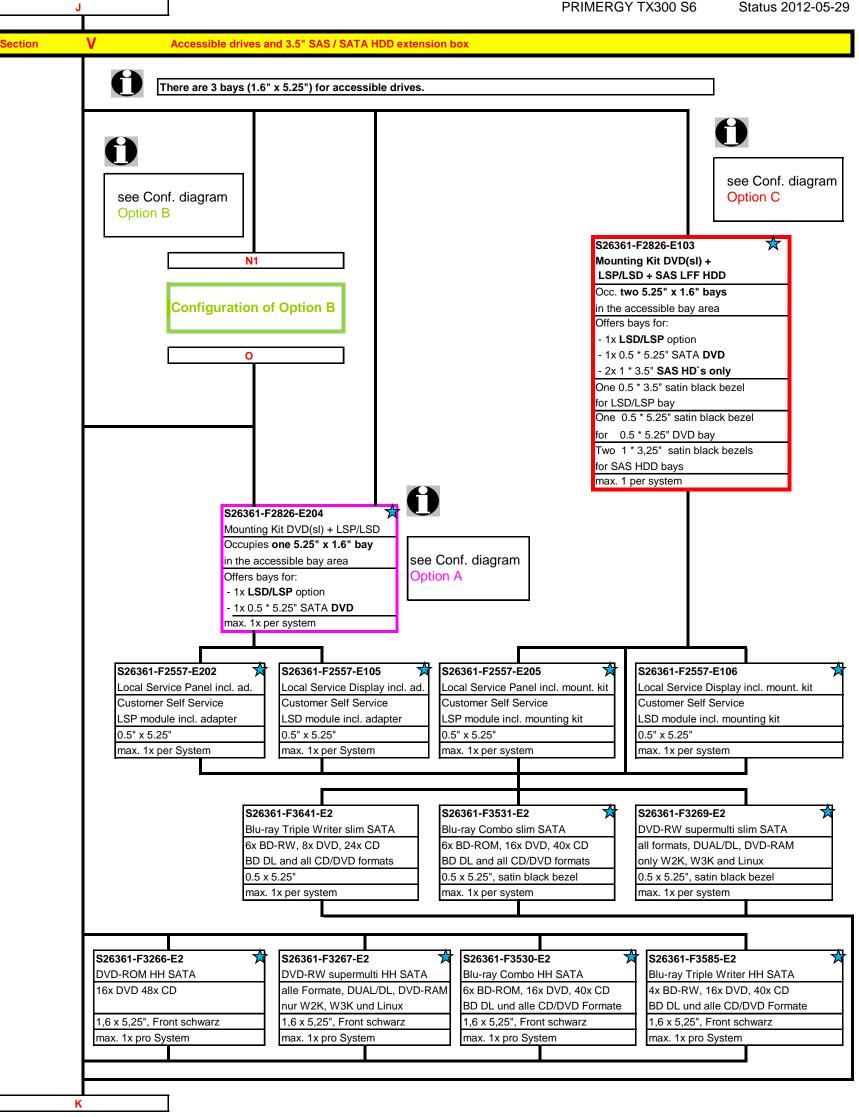


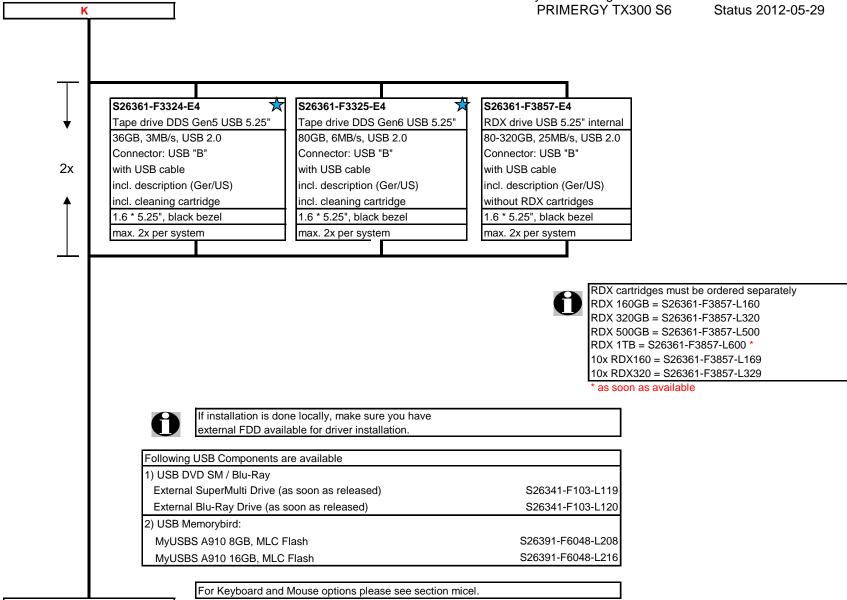
Performance Channel Mode requires identical modules on all channels of each Bank per CPU

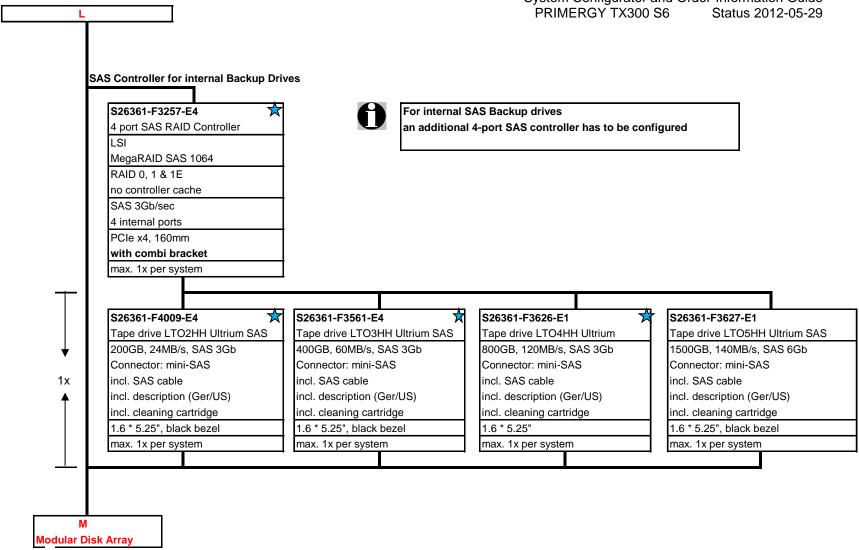
4. Spare Channel Mode

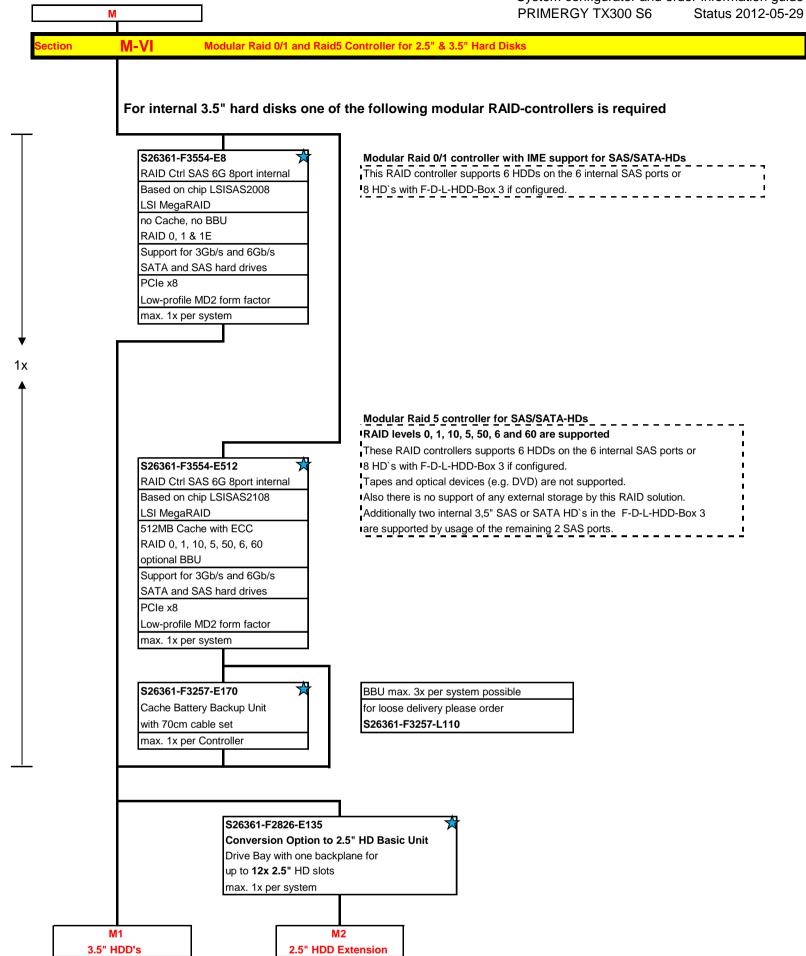


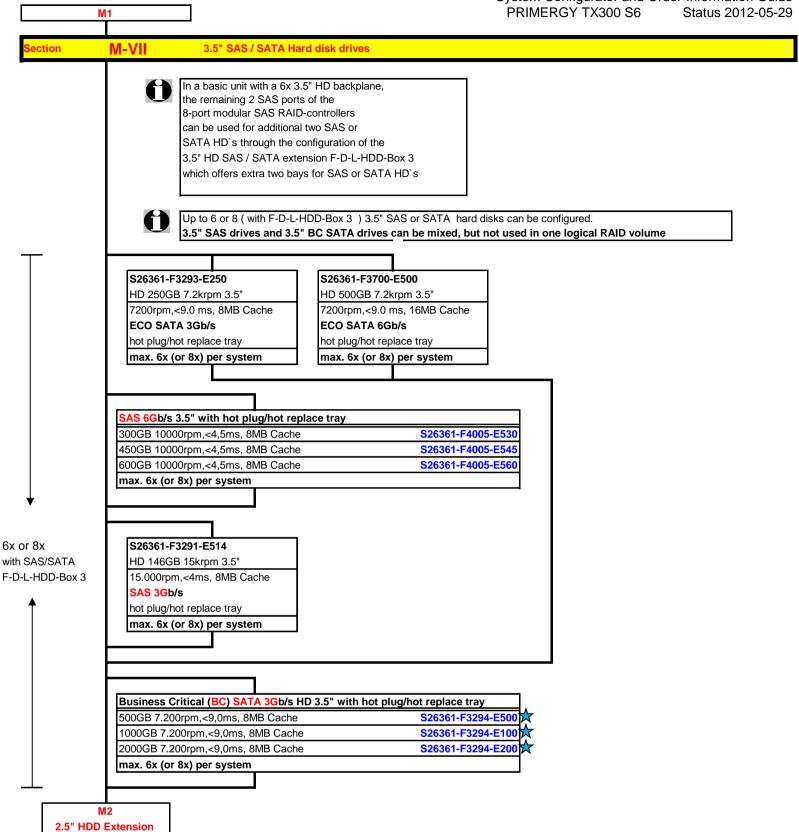
Spare Channel Mode requires identical modules (same capacity and technology) on all channels of each Bank per CPU one third of the capacity is used for the spare => the available memory for applications is two thirds of the installed memory Fujitsu Technology Solutions x86 PRIMERGY Server

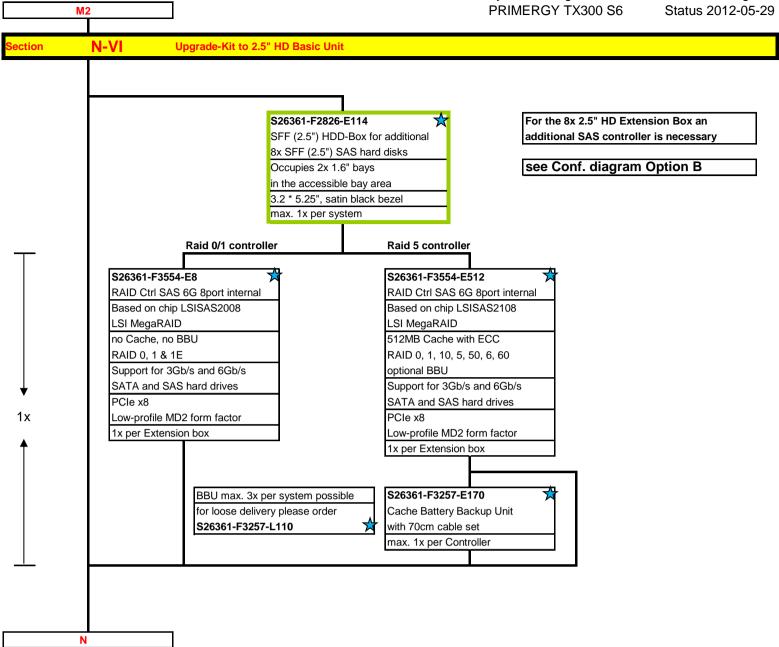


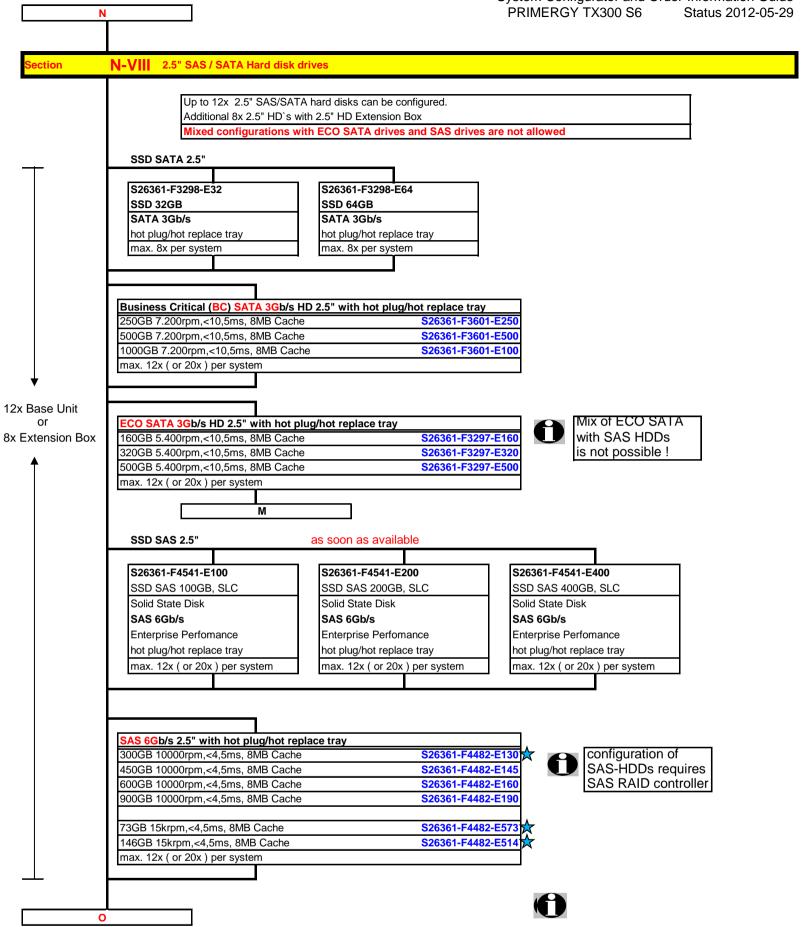


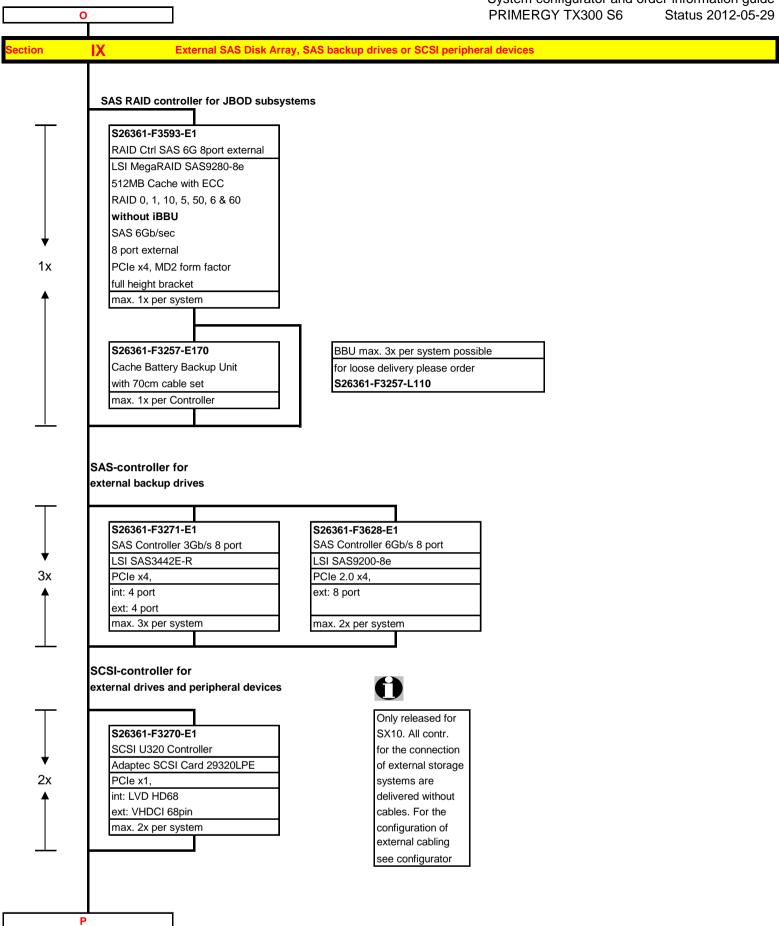


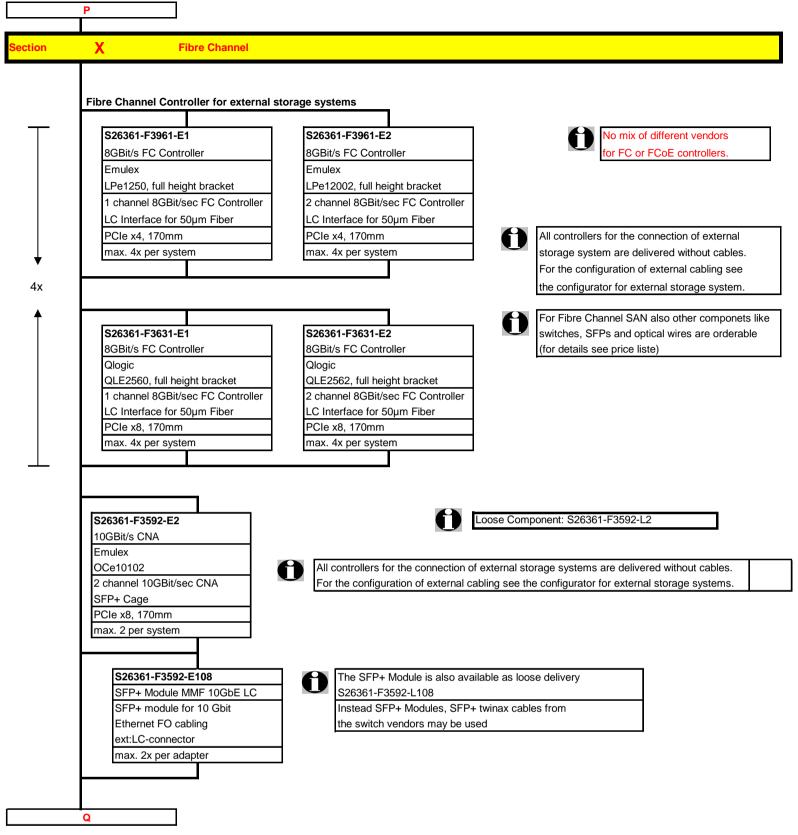


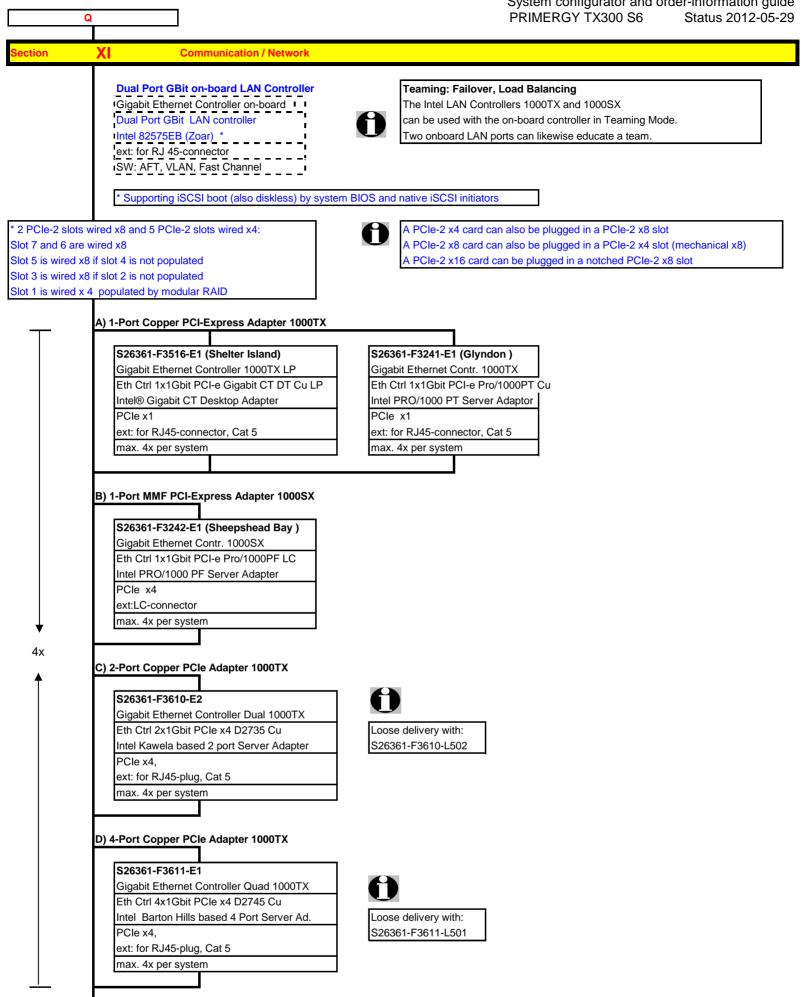




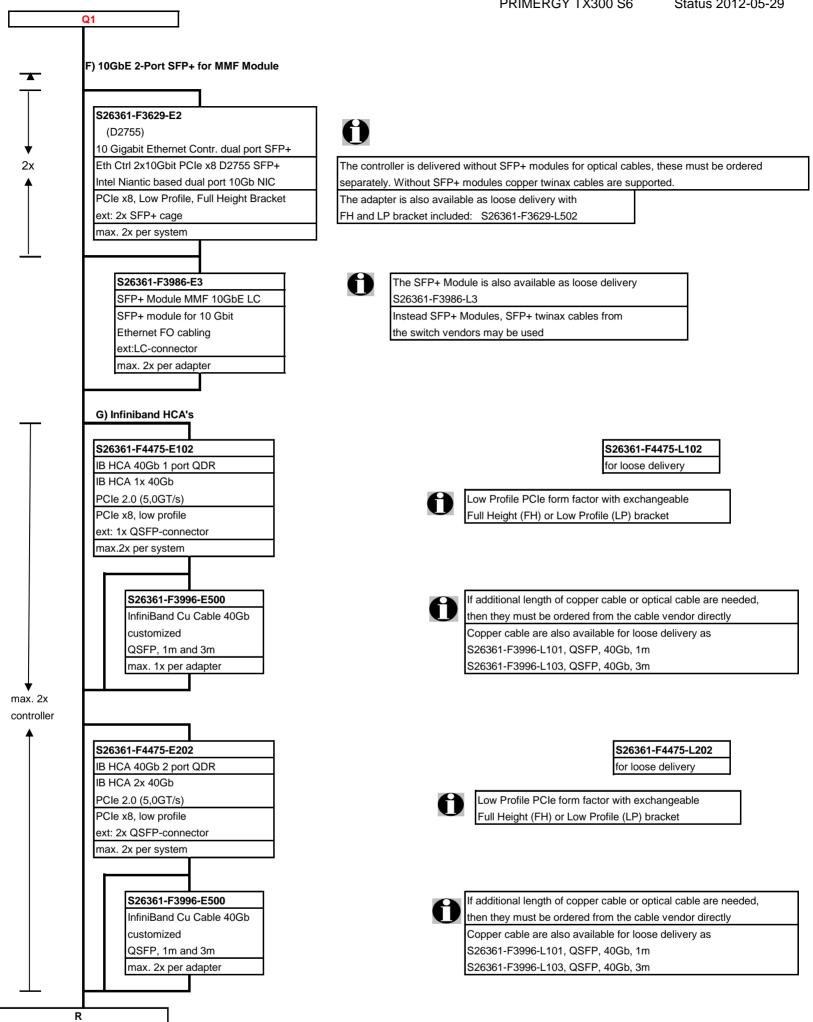


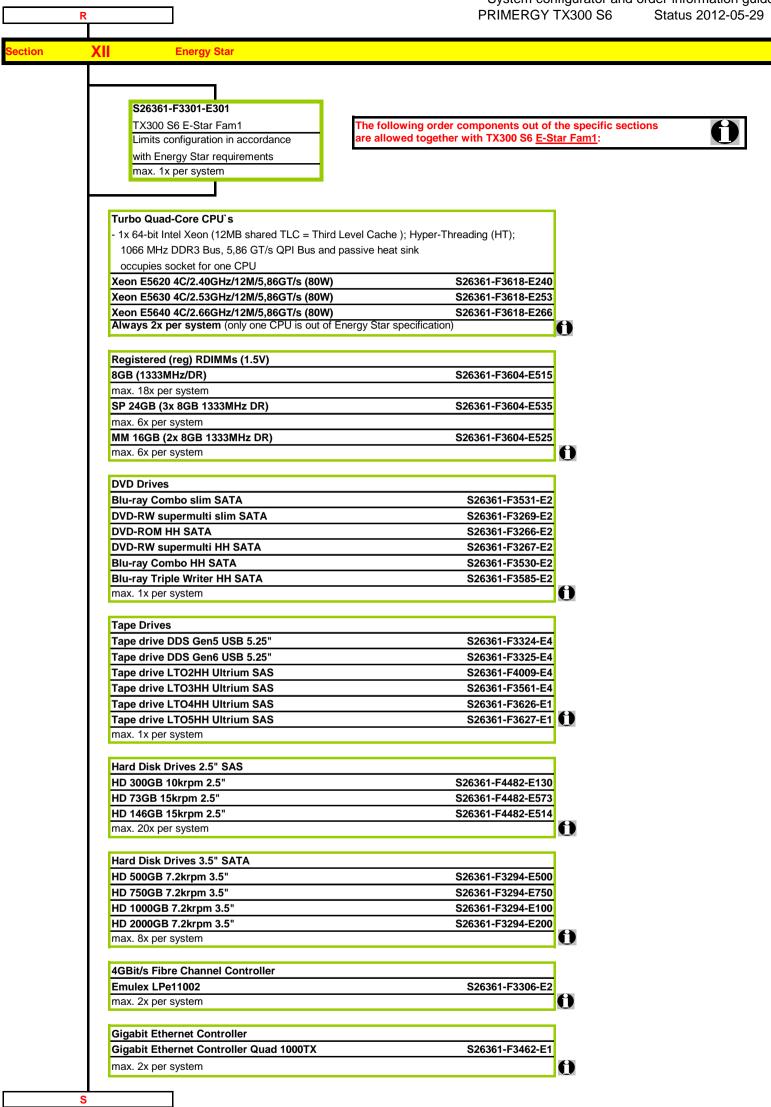


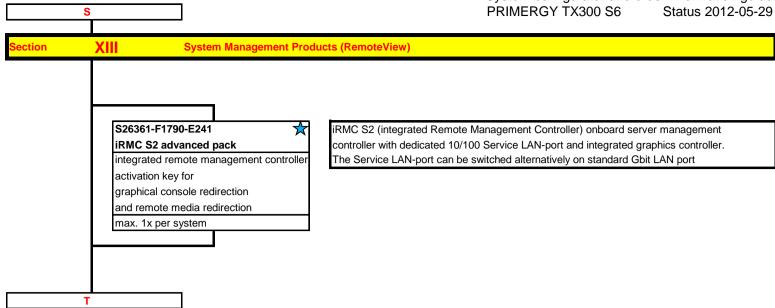


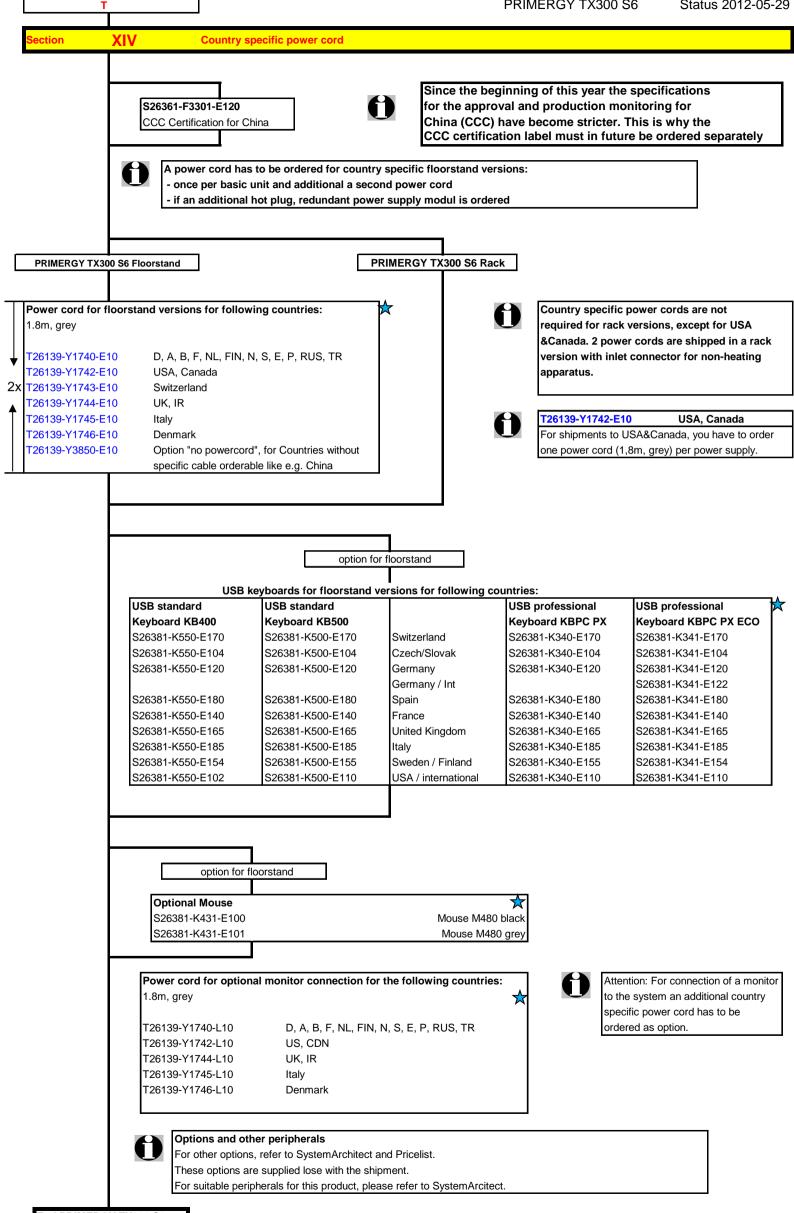


Q1









Change Report

Date	Order number	Changes
2012-02-28	S26361-F3301-E120	add CCC Certification
2012-01-30	S26361-F3641-E2	new Blue-ray Triple Writer added
2012-01-25	S26361-F3700-E500	500GB 3.5" ECO-SATA 6G added by Ö. Karakas
2011-12-21	S26361-F4482-E114	SAS HD 6G 144GB - no longer available
2011-12-21	S26361-F4492-E516	New 16GB 2R 1333 memory module on status 35
2011-11-23	S26361-F4541-Ex00	new SAS SSD with 100, 200, 400 GB added - as soon as available
2011-10-00	S26361-F3601-E250	new BC SATA HD - now available
2011-10-01	S26361-F3298-E64	64 GB SSD - no longer available
2011-10-01	S26361-F4482-E190	new 6Gb SAS-HD 900GB - as soon as available
2011-06-09	S26361-F3604-E517	32GB QR Module added on special release
2011-05-03 2011-04-07	S26361-F3610-E2/L502	Formal change from E1 / L501
	S26361-F2735-L202	Adapter angleL31 must be ordered for asym. PC/DC racks additionally
2011-03-31	S26361-F3629-E2	10 Gigabit Ethernet controller added
2011-02-21		Corrected notched slots in configuration diagram
2011-01-19	000004 50040 5400	Data Cartridges removed from DDS & LTO drive description
2011-01-10	S26361-F3648-E160	Westmere-EP Refresh CPUs added
2010-12-16	S26361-F3228-L1	Intel Dual & Quad Port Ethernet Adapter removed
2010-12-30	S26361-F3585-E2	Blu-ray Triple Writer HH SATA - now available
2010-11-18	S26361-F3628-E1	Ctrl SAS 6G 8port external added
2010-09-30	S26361-F3555-E1	10 Gigabit Ethernet Controller - now available
2010-09-30	S26361-F3505-E1	10 Gigabit Ethernet Controller - no longer available
2010-09-30	S26361-F3627-E1	New LTO5 SAS drive - now available
2010-09-13	S26361-F3626-E1	Upgrade - New LTO4 SAS drive
2010-08-26		RDX Cartridges Update
2010-08-23	S26381-K341-E122	Germany / Int Keyboard added
2010-08-01	S26361-F3611-E1	New Quad LAN GbE controller - as soon as available
2010-08-01	S26361-F3610-E1	New Dual LAN GbE controller - as soon as available
2010-07-16		No longer 3.5" HDD SAS Drives because of system architect restrictions
2010-07-05		EPA restrictions implemented
2010-06-23	S26381-K431-E101	Added Mouse M480 grey
2010-05-12	S26381-K341-E1**	Added USB professional Keyboard KBPC PX ECO (available from July 2010)
2010-05-04		SAS RAID Controller descriptions updated
2010-03-22		Added USB Standard Keyboard KB400
2010-03-01		First Release